

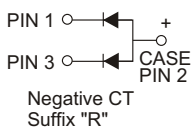
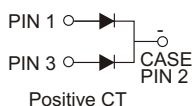


## FEATURES

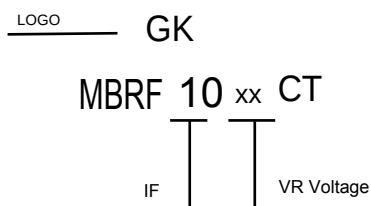
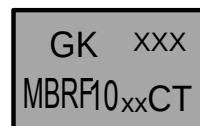
- \* Low forward voltage drop
- \* High current capability
- \* High reliability
- \* High surge current capability
- \* Good for switching mode application

## MECHANICAL DATA

- \* Case: Molded plastic
- \* Epoxy: UL 94V-0 rate flame retardant
- \* Lead: Axial leads, solderable per MIL-STD-202, method 208 guaranteed
- \* Polarity: Color band denotes cathode end
- \* Mounting position: Any



**VOLTAGE RANGE**  
20 to 200 Volts  
**CURRENT**  
10.0 Ampere



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.  
Single phase half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

| TYPE NUMBER                                                                                        | MBRF1020CT | MBRF1045CT | MBRF1060CT | MBRF1080CT | MBRF10100CT | MBRF10150CT | MBRF10200CT | UNITS |
|----------------------------------------------------------------------------------------------------|------------|------------|------------|------------|-------------|-------------|-------------|-------|
| Maximum Recurrent Peak Reverse Voltage                                                             | 20         | 45         | 60         | 80         | 100         | 150         | 200         | V     |
| Maximum RMS Voltage                                                                                | 14         | 32         | 42         | 56         | 70          | 105         | 140         | V     |
| Maximum DC Blocking Voltage                                                                        | 20         | 45         | 60         | 80         | 100         | 150         | 200         | V     |
| Maximum Average Forward Rectified Current                                                          | 10         |            |            |            |             |             |             | A     |
| Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method) | 150        |            |            |            |             |             |             | A     |
| Maximum Instantaneous Forward Voltage at 10A                                                       | 0.55       | 0.7        | 0.85       |            | 0.92        |             | V           |       |
| Maximum DC Reverse Current Ta=25°C                                                                 | 0.1        |            |            | 0.02       |             |             | mA          |       |
| at Rated DC Blocking Voltage Ta=100°C                                                              | 5          |            |            | 2          |             |             | mA          |       |
| Typical Junction Capacitance (Note1)                                                               | 420        |            |            |            |             |             |             | pF    |
| Typical Thermal Resistance RθJC (Note 2)                                                           | 2.5        |            |            |            |             |             |             | °C/W  |
| Operating Temperature Range Tj                                                                     | -65 — +175 |            |            |            |             |             |             | °C    |
| Storage Temperature Range Tstg                                                                     | -65 — +175 |            |            |            |             |             |             | °C    |

### NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. Thermal Resistance Junction to Case.

## RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

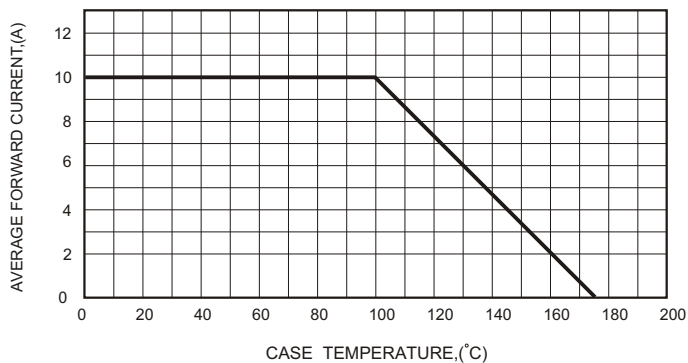


FIG.2-TYPICAL FORWARD CHARACTERISTICS

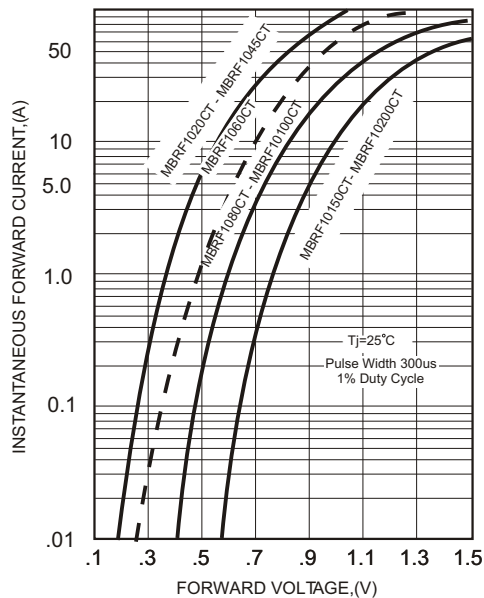


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

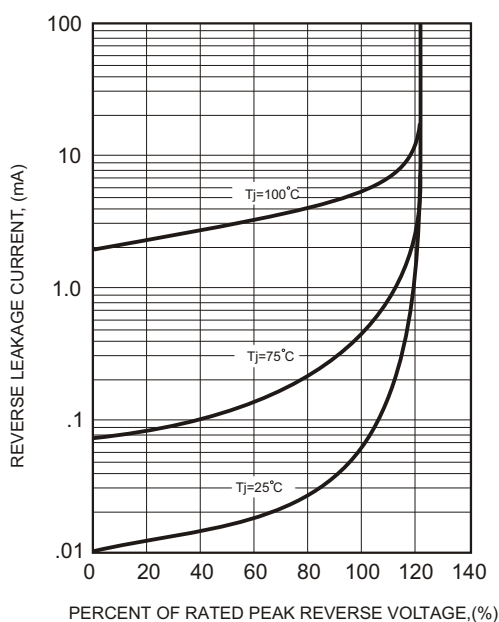


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

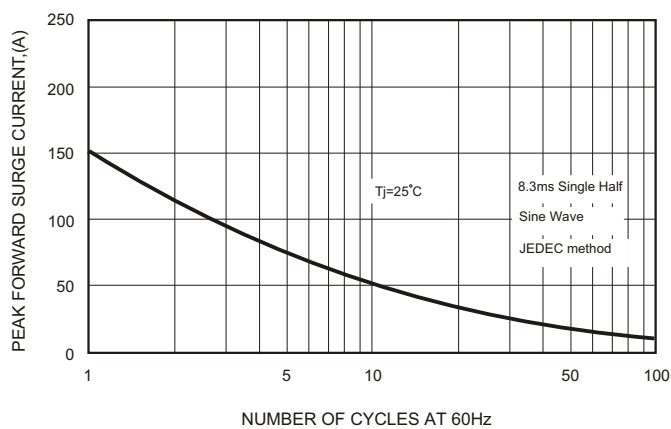
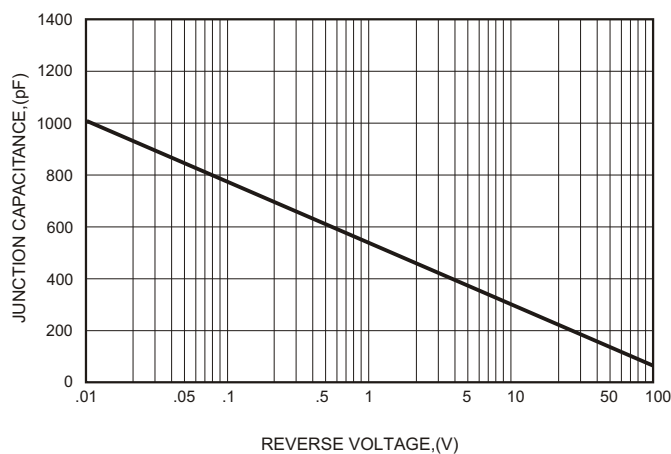
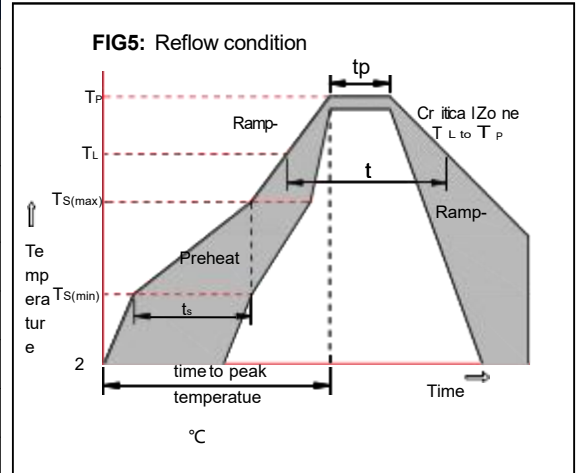


FIG.5-TYPICAL JUNCTION CAPACITANCE



## Soldering parameters

| Reflow Condition                                        |                                   | Pb-Free assembly<br>(see as below) |
|---------------------------------------------------------|-----------------------------------|------------------------------------|
| Pre Heat                                                | -Temperature Min ( $T_{s(min)}$ ) | +150 °C                            |
|                                                         | -Temperature Max( $T_{s(max)}$ )  | +200 °C                            |
|                                                         | -Time (Min to Max) (ts)           | 60-180 secs.                       |
| Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak) |                                   | 3 °C/sec. Max                      |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                    |                                   | 3 °C/sec. Max                      |
| Reflow                                                  | -Temperature( $T_L$ )(Liquid us)  | +217 °C                            |
|                                                         | -Temperature( $t_L$ )             | 60-150 secs.                       |
| Peak Temp ( $T_P$ )                                     |                                   | +260(+0/-5) °C                     |
| Time within 5 °C of actual Peak Temp ( $t_P$ )          |                                   | 30 secs. Max                       |
| Ramp-down Rate                                          |                                   | 6 °C/sec. Max                      |
| Time 25 °C to Peak Temp ( $T_P$ )                       |                                   | 8 min. Max                         |
| Do not exceed                                           |                                   | +260 °C                            |



## Package Dimensions & Suggested Pad Layout

